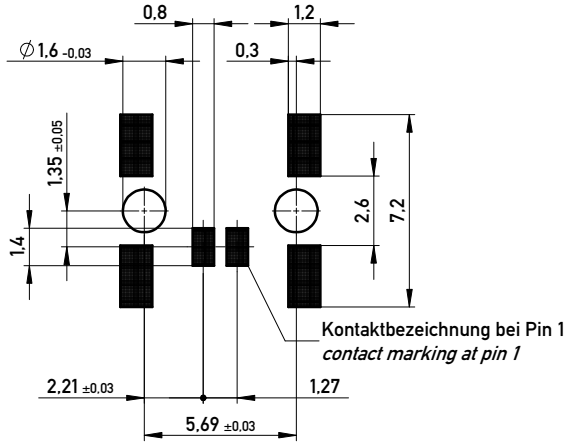
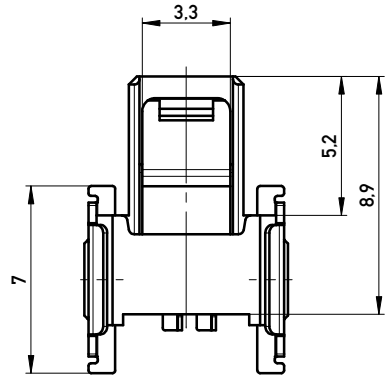
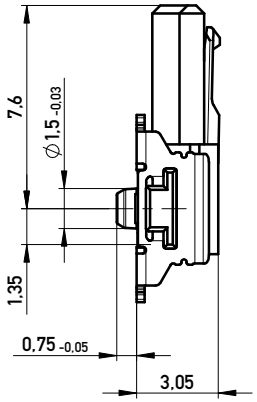
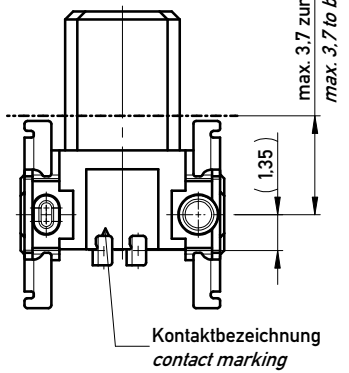
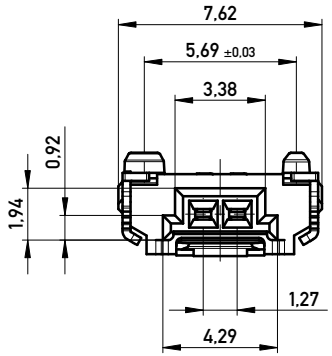
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT











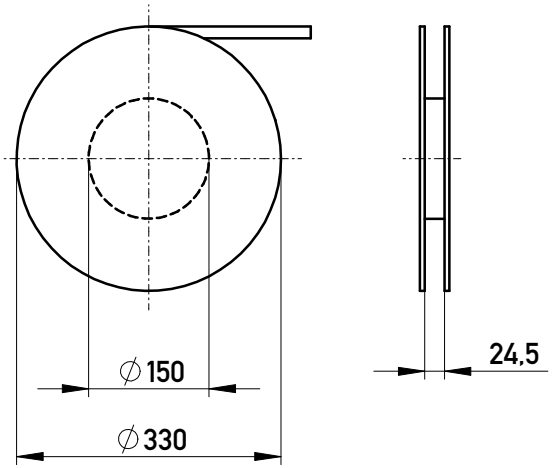
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

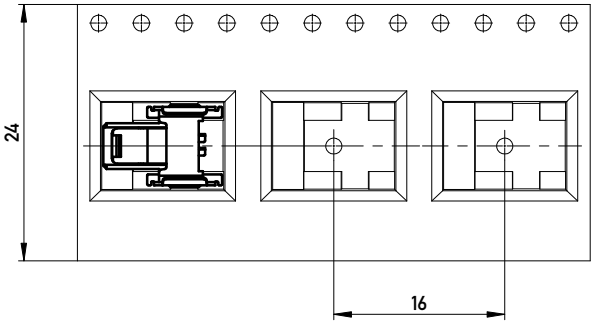
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt in Gurtverpackung - *Tape on Reel Packaging*
Verpackungseinheit: 850 Stück - *Packaging unit: 850 pcs*



Abspulrichtung - *Reel off Direction*



mit Verriegelung
with locking mechanism

Information:	Tolerances	All Dimensions in mm	Scale 5:1
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		ERNI www.ERNI.com	100101920001 K
Index	18.05.2011 Date		Class SRCP A3

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